## 1 General description

The PCA9545A is a quad bidirectional translating switch controlled via the  $I^2$ C-bus. The SCL/SDA upstream pair fans out to four downstream pairs, or channels. Any individual SCx/SDx channel or combination of channels can be selected, determined by the contents of the programmable control register. Four interrupt inputs,  $\overline{INTO}$  to  $\overline{INTO}$ , one for each of the downstream pairs, are provided. One interrupt output,  $\overline{INT}$ , acts as an AND of the four interrupt inputs.

An active LOW reset input allows the PCA9545A to recover from a situation where one of the downstream  $I^2C$ -buses is stuck in a LOW state. Pulling the  $\overline{RESET}$  pin LOW resets the  $I^2C$ -bus state machine and causes all the channels to be deselected as does the internal power-on reset function.

The pass gates of the switches are constructed such that the  $V_{DD}$  pin can be used to limit the maximum high voltage which is passed by the PCA9545A. This allows the use of different bus voltages on each pair, so that 1.8 V or 2.5 V or 3.3 V parts can communicate with 5 V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5 V tolerant.

### 2 Features and benefits

- 1-of-4 bidirectional translating switches
- I<sup>2</sup>C-bus interface logic; compatible with SMBus standards
- · Four active LOW interrupt inputs
- Active LOW interrupt output
- Active LOW reset input
- Two address pins allowing up to four devices on the I<sup>2</sup>C-bus
- Channel selection via I<sup>2</sup>C-bus, in any combination
- · Power-up with all switch channels deselected
- · Low Ron switches
- Allows voltage level translation between 1.8 V, 2.5 V, 3.3 V and 5 V buses
- No glitch on power-up
- · Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 5 V tolerant Inputs
- 0 Hz to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114 and 1000 V CDM per JESD22-C101
- Latch-up protection exceeds 100 mA per JESD78
- Three packages offered: SO20, TSSOP20, and HVQFN20



4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 3 Ordering information

#### Table 1. Ordering information

| Type number | Topside   | Package | Package  |          |  |  |  |  |  |
|-------------|-----------|---------|--|----------|--|--|--|--|--|
|             | marking   | Name    | Description  | Version  |  |  |  |  |  |
| PCA9545ABS  | 9545A     | HVQFN20 | plastic thermal enhanced very thin quad flat package; no leads; 20 terminals; body 5 × 5 × 0.85 mm | SOT662-1 |  |  |  |  |  |
| PCA9545AD   | PCA9545AD | SO20    | plastic small outline package; 20 leads; body width 7.5 mm   | SOT163-1 |  |  |  |  |  |
| PCA9545APW  | PA9545A   | TSSOP20 | plastic thin shrink small outline package; 20 leads; body width 4.4 mm                             | SOT360-1 |  |  |  |  |  |

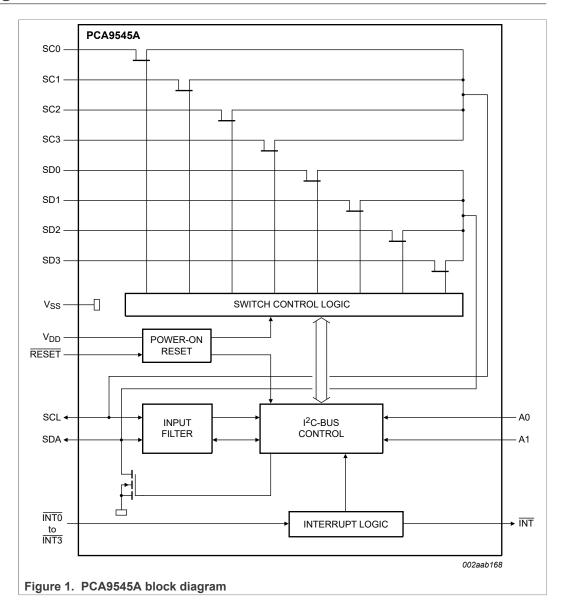
## 3.1 Ordering options

Table 2. Ordering options

| Type number | Orderable part number | Package | Packing method                               | Minimum order quantity | Temperature range                   |
|-------------|-----------------------|---------|--|------------------------|-------------------------------------|
| PCA9545ABS  | PCA9545ABS,118        | HVQFN20 | Reel 13" Q1/T1<br>*standard mark SMD         | 6000                   | $T_{amb}$ = -40 °C to +85 °C        |
| PCA9545AD   | PCA9545AD,112         | SO20    | Standard marking * IC's tube - DSC bulk pack | 1520                   | $T_{amb}$ = -40 °C to +85 °C        |
|             | PCA9545AD,118         | SO20    | Reel 13" Q1/T1<br>*standard mark SMD         | 2000                   | $T_{amb}$ = -40 °C to +85 °C        |
| PCA9545APW  | PCA9545APW,112        | TSSOP20 | Standard marking * IC's tube - DSC bulk pack | 1875                   | $T_{amb}$ = -40 °C to +85 °C        |
|             | PCA9545APW,118        | TSSOP20 | Reel 13" Q1/T1 *standard mark SMD            | 2500                   | T <sub>amb</sub> = -40 °C to +85 °C |

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

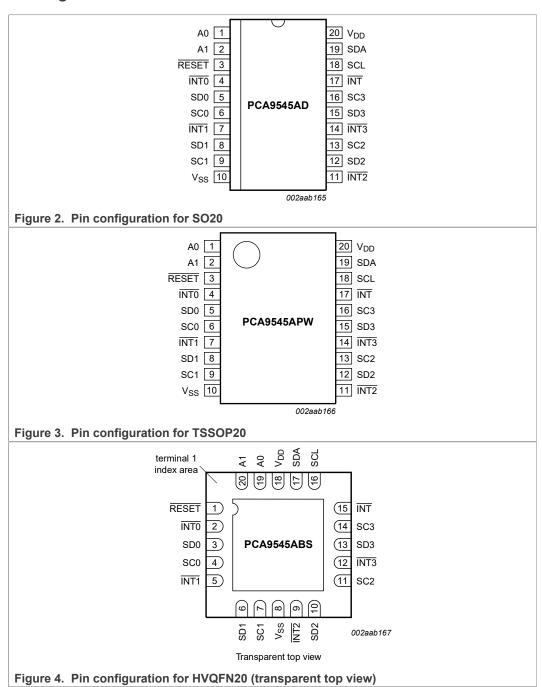
# 4 Block diagram



4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 5 Pinning information

### 5.1 Pinning



## 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 5.2 Pin description

Table 3. Pin description

| Symbol          | Pin           |                  | Description                  |
|-----------------|---------------|------------------|------------------------------|
|                 | SO20, TSSOP20 | HVQFN20          |                              |
| A0              | 1             | 19               | address input 0              |
| A1              | 2             | 20               | address input 1              |
| RESET           | 3             | 1                | active LOW reset input       |
| ĪNT0            | 4             | 2                | active LOW interrupt input 0 |
| SD0             | 5             | 3                | serial data 0                |
| SC0             | 6             | 4                | serial clock 0               |
| ĪNT1            | 7             | 5                | active LOW interrupt input 1 |
| SD1             | 8             | 6                | serial data 1                |
| SC1             | 9             | 7                | serial clock 1               |
| V <sub>SS</sub> | 10            | 8 <sup>[1]</sup> | supply ground                |
| ĪNT2            | 11            | 9                | active LOW interrupt input 2 |
| SD2             | 12            | 10               | serial data 2                |
| SC2             | 13            | 11               | serial clock 2               |
| ĪNT3            | 14            | 12               | active LOW interrupt input 3 |
| SD3             | 15            | 13               | serial data 3                |
| SC3             | 16            | 14               | serial clock 3               |
| ĪNT             | 17            | 15               | active LOW interrupt output  |
| SCL             | 18            | 16               | serial clock line            |
| SDA             | 19            | 17               | serial data line             |
| $V_{DD}$        | 20            | 18               | supply voltage               |

<sup>[1]</sup> HVQFN20 package die supply ground is connected to both the V<sub>SS</sub> pin and the exposed center pad. The V<sub>SS</sub> pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board-level performance, the exposed pad must be soldered to the board using a corresponding thermal pad on the board, and for proper heat conduction through the board thermal vias must be incorporated in the PCB in the thermal pad region.

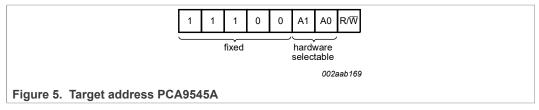
4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

### 6 Functional description

Refer to Figure 1.

#### 6.1 Device address

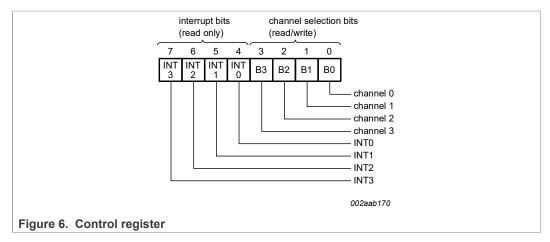
Following a START condition, the bus controller must output the address of the target it is accessing. The address of the PCA9545A is shown in <a href="Figure 5">Figure 5</a>. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.



The last bit of the target address defines the operation to be performed. When set to logic 1, a read is selected while a logic 0 selects a write operation.

### 6.2 Control register

Following the successful acknowledgement of the target address, the bus controller sends a byte to the PCA9545A, which is stored in the control register. If multiple bytes are received by the PCA9545A, it saves the last byte received. This register can be written and read via the  $I^2$ C-bus.



### 6.2.1 Control register definition

One or several SCx/SDx downstream pair, or channel, is selected by the contents of the control register. This register is written after the PCA9545A has been addressed. The 4 LSBs of the control byte are used to determine which channel is to be selected. When a channel is selected, the channel will become active after a STOP condition has been placed on the I<sup>2</sup>C-bus. This ensures that all SCx/SDx lines are in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection.

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

| INT3    | INT2 | INT1 | INT0 | B3 | B2 | B1 | В0 | Command   |
|---------|------|------|------|----|----|----|----|---|
| X       | X    | X    | X    | x  | x  | x  | 0  | channel 0 disabled                                    |
| ^       | ^    | ^    | ^    | ^  | ^  | ^  | 1  | channel 0 enabled                                     |
| <u></u> | X    | X    | X    | x  | x  | 0  | _x | channel 1 disabled                                    |
| Χ       | ^    | ^    | ^    | ^  | ^  | 1  | ^  | channel 1 enabled                                     |
| X       | X    | X    | X    | x  | 0  | X  | V  | channel 2 disabled                                    |
| ^       | ^    | ^    | ^    | ^  | 1  | _^ | X  | channel 2 enabled                                     |
| ~       | X    |      | X    | 0  | X  | V  | V  | channel 3 disabled                                    |
| Χ       | ^    | X    | ^    | 1  | _^ | X  | X  | channel 3 enabled                                     |
| 0       | 0    | 0    | 0    | 0  | 0  | 0  | 0  | no channel selected; power-<br>up/reset default state |

Table 4. Control register: write (channel selection); read (channel status)

**Remark:** Several channels can be enabled at the same time. Example: B3 = 0, B2 = 1, B1 = 1, B0 = 0, means that channel 0 and channel 3 are disabled and channel 1 and channel 2 are enabled. Care should be taken not to exceed the maximum bus capacity.

#### 6.2.2 Interrupt handling

The PCA9545A provides four interrupt inputs, one for each channel, and one opendrain interrupt output. When an interrupt is generated by any device, it is detected by the PCA9545A and the interrupt output is driven LOW. The channel does not need to be active for detection of the interrupt. A bit is also set in the control register.

Bit 4 through bit 7 of the control register corresponds to channel 0 through channel 3 of the PCA9545A, respectively. Therefore, if an interrupt is generated by any device connected to channel 1, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 would cause bit 4 of the control register to be set on the read. The controller can then address the PCA9545A and read the contents of the control register to determine which channel contains the device generating the interrupt. The controller can then reconfigure the PCA9545A to select this channel, and locate the device generating the interrupt and clear it.

It should be noted that more than one device can provide an interrupt on a channel, so it is up to the controller to ensure that all devices on a channel are interrogated for an interrupt.

If the interrupt function is not required, the interrupt inputs may be used as general-purpose inputs.

If unused, interrupt inputs must be connected to V<sub>DD</sub> through a pull-up resistor.

Table 5. Control register: Read — interrupt

| Tubic o. | able of Control register. Read — interrupt |      |      |    |    |    |    |                           |  |  |
|----------|--|------|------|----|----|----|----|---------------------------|--|--|
| INT3     | INT2                                       | INT1 | INT0 | В3 | B2 | B1 | В0 | Command                   |  |  |
| v        | v  | v    | 0    | v  | v  | v  | V  | no interrupt on channel 0 |  |  |
| ^        | x x  | ^    | 1    | ^  | ^  | ^  | ^  | interrupt on channel 0    |  |  |
| V        | _  | 0    | v    | ~  | ~  | ~  | _  | no interrupt on channel 1 |  |  |
| ^        | ^  | 1    | ^    | ^  | ^  | ^  | X  | interrupt on channel 1    |  |  |

PCA9545A

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Table 5. Control register: Read — interrupt...continued

| INT3 | INT2 | INT1 | INT0 | В3 | B2 | B1   | В0 | Command                   |
|------|------|------|------|----|----|------|----|---------------------------|
| v    | 0    | v    | х    | v  | v  | v    | V  | no interrupt on channel 2 |
| ^    | 1    | ^    | ^    | ^  | ^  | ^    | X  | interrupt on channel 2    |
| 0    | v    | v    | х    | v  | v  | v    | v  | no interrupt on channel 3 |
| 1    | ^    | ^    | ^    | ^  | ^  | ^  ^ |    | interrupt on channel 3    |

**Remark:** Several interrupts can be active at the same time. Example: INT3 = 0, INT2 = 1, INT1 = 1, INT0 = 0, means that there is no interrupt on channel 0 and channel 3, and there is interrupt on channel 1 and channel 2.

### 6.3 RESET input

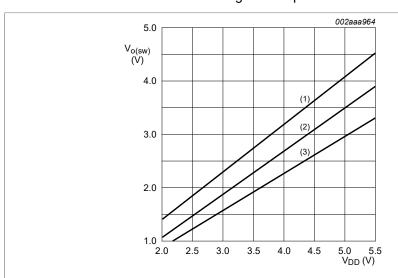
The RESET input is an active LOW signal which may be used to recover from a bus fault condition. By asserting this signal LOW for a minimum of  $t_{w(rst)L}$ , the PCA9545A resets its registers and I<sup>2</sup>C-bus state machine and deselects all channels. The RESET input must be connected to  $V_{DD}$  through a pull-up resistor.

#### 6.4 Power-on reset

When power is applied to  $V_{DD}$ , an internal Power-On Reset (POR) holds the PCA9545A in a reset condition until  $V_{DD}$  has reached  $V_{POR}$ . At this point, the reset condition is released and the PCA9545A registers and  $I^2C$ -bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter,  $V_{DD}$  must be lowered below 0.2 V for at least 5  $\mu$ s in order to reset the device.

#### 6.5 Voltage translation

The pass gate transistors of the PCA9545A are constructed such that the  $V_{DD}$  voltage can be used to limit the maximum voltage that is passed from one  $I^2C$ -bus to another.



- 1. maximum
- 2. typical
- 3. minimum

Figure 7. Pass gate voltage versus supply voltage

PCA9545A

### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Figure 7 shows the voltage characteristics of the pass gate transistors (note that the graph was generated using the data specified in Section 11 of this data sheet). In order for the PCA9545A to act as a voltage translator, the  $V_{o(sw)}$  voltage should be equal to, or lower than the lowest bus voltage. For example, if the main bus was running at 5 V, and the downstream buses were 3.3 V and 2.7 V, then  $V_{o(sw)}$  should be equal to or below 2.7 V to clamp the downstream bus voltages effectively. Looking at Figure 7, we see that  $V_{o(sw)(max)}$  is at 2.7 V when the PCA9545A supply voltage is 3.5 V or lower, so the PCA9545A supply voltage could be set to 3.3 V. Pull-up resistors can then be used to bring the bus voltages to their appropriate levels (see Figure 14).

More Information can be found in Application Note *AN262: PCA954X family of I*<sup>2</sup>C/SMBus multiplexers and switches.

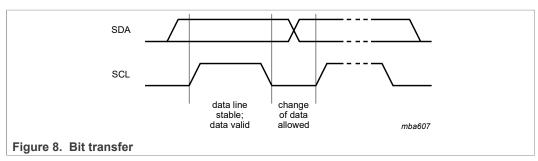
4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

# 7 Characteristics of the I<sup>2</sup>C-bus

The I<sup>2</sup>C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

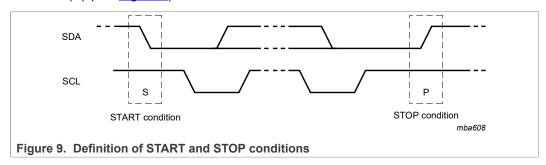
#### 7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse, as changes in the data line at this time are interpreted as control signals (see Figure 8).



#### 7.2 START and STOP conditions

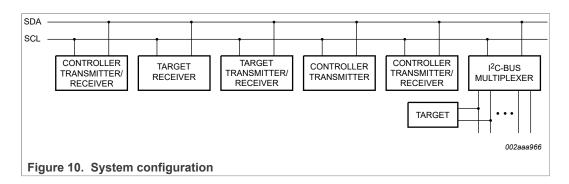
Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see Figure 9).



#### 7.3 System configuration

A device generating a message is a 'transmitter', a device receiving is the 'receiver'. The device that controls the message is the 'controller' and the devices which are controlled by the controller are the 'targets' (see <u>Figure 10</u>).

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

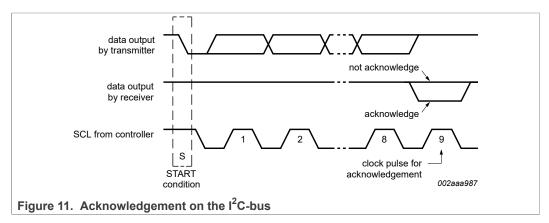


#### 7.4 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of 8 bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the controller generates an extra acknowledge related clock pulse.

A target receiver which is addressed must generate an acknowledge after the reception of each byte. Also a controller must generate an acknowledge after the reception of each byte that has been clocked out of the target transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

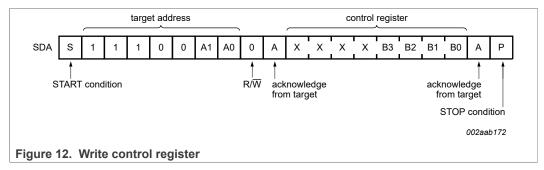
A controller receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the target. In this event, the transmitter must leave the data line HIGH to enable the controller to generate a STOP condition.



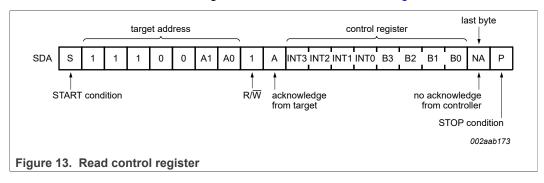
#### 7.5 Bus transactions

Data is transmitted to the PCA9545A control register using the Write mode as shown in Figure 12.

### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

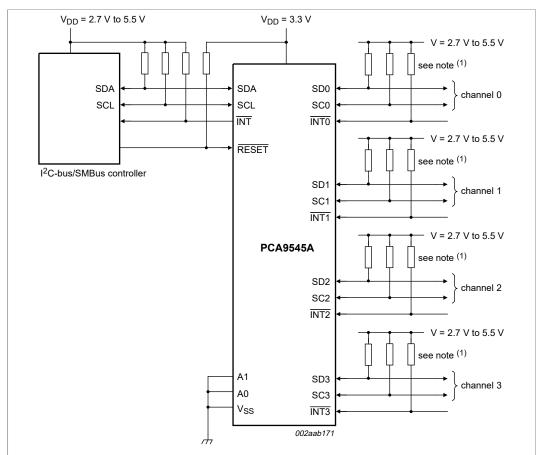


Data is read from PCA9545A using the Read mode as shown in Figure 13.



4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 8 Application design-in information



1. If the device generating the interrupt has an open-drain output structure or can be 3-stated, a pull-up resistor is required.

If the device generating the interrupt has a totem-pole output structure and cannot be 3-stated, a pull-up resistor is not required.

The interrupt inputs should not be left floating.

Figure 14. Typical application

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 9 Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS}$  (ground = 0 V).

| Symbol              | Parameter                    | Conditions |     | Min  | Max  | Unit |
|---------------------|------------------------------|------------|-----|------|------|------|
| $V_{DD}$            | supply voltage               |            |     | -0.5 | +7.0 | V    |
| VI                  | input voltage                |            |     | -0.5 | +7.0 | V    |
| I <sub>I</sub>      | input current                |            |     | -    | ±20  | mA   |
| Io                  | output current               |            |     | -    | ±25  | mA   |
| I <sub>DD</sub>     | supply current               |            |     | -    | ±100 | mA   |
| I <sub>SS</sub>     | ground supply current        |            |     | -    | ±100 | mA   |
| P <sub>tot</sub>    | total power dissipation      |            |     | -    | 400  | mW   |
| T <sub>j(max)</sub> | maximum junction temperature |            | [1] | -    | 125  | °C   |
| T <sub>stg</sub>    | storage temperature          |            |     | -60  | +150 | °C   |
| T <sub>amb</sub>    | ambient temperature          | operating  |     | -40  | +85  | °C   |

<sup>[1]</sup> The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 125 °C.

### 10 Thermal characteristics

Table 7. Thermal characteristics

| Symbol               | Parameter                        | Conditions      | Тур | Unit |
|----------------------|----------------------------------|-----------------|-----|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction | HVQFN20 package | 32  | °C/W |
|                      | to ambient                       | SO20 package    | 90  | °C/W |
|                      |                                  | TSSOP20 package | 146 | °C/W |

## 11 Static characteristics

Table 8. Static characteristics at  $V_{DD}$  = 2.3 V to 3.6 V

 $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified. See <u>Table 9</u> for  $V_{DD}$  = 4.5 V to 5.5  $V_{col}$ 

| Symbol           | Parameter               | Conditions  |     | Min  | Тур | Max                 | Unit |
|------------------|-------------------------|---|-----|------|-----|---------------------|------|
| Supply           |                         |   |     |      | '   | '                   |      |
| V <sub>DD</sub>  | supply voltage          |   |     | 2.3  | -   | 3.6                 | V    |
| I <sub>DD</sub>  | supply current          | Operating mode; $V_{DD}$ = 3.6 V; no load; $V_{I}$ = $V_{DD}$ or $V_{SS}$ ; $f_{SCL}$ = 100 kHz |     | -    | 10  | 30                  | μA   |
| I <sub>stb</sub> | standby current         | Standby mode; $V_{DD}$ = 3.6 V; no load; $V_{I}$ = $V_{DD}$ or $V_{SS}$                         |     | -    | 0.1 | 1                   | μA   |
| V <sub>POR</sub> | power-on reset voltage  | no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub>                                    | [2] | -    | 1.6 | 2.1                 | V    |
| Input SC         | L; input/output SDA     |   |     |      |     |                     |      |
| V <sub>IL</sub>  | LOW-level input voltage |   |     | -0.5 | -   | +0.3V <sub>DD</sub> | V    |

PCA9545A

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### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Table 8. Static characteristics at  $V_{DD}$  = 2.3 V to 3.6 V...continued

 $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified. See <u>Table 9</u> for  $V_{DD}$  = 4.5 V to 5.5  $V_{col}$ 

| Symbol             | Parameter                    | Conditions   | Min                | Тур | Max                 | Unit |
|--------------------|------------------------------|--|--------------------|-----|---------------------|------|
| V <sub>IH</sub>    | HIGH-level input voltage     |  | 0.7V <sub>DD</sub> | -   | 6                   | V    |
| I <sub>OL</sub>    | LOW-level output current     | V <sub>OL</sub> = 0.4 V  | 3                  | 7   | -                   | mA   |
|                    |                              | V <sub>OL</sub> = 0.6 V  | 6                  | 10  | -                   | mA   |
| IL                 | leakage current              | V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub>                                    | -1                 | -   | +1                  | μΑ   |
| C <sub>i</sub>     | input capacitance            | V <sub>I</sub> = V <sub>SS</sub>   | -                  | 10  | 13                  | pF   |
| Select in          | puts A0, A1, INTO to INT3, F | RESET  |                    | '   | '                   |      |
| V <sub>IL</sub>    | LOW-level input voltage      |  | -0.5               | -   | +0.3V <sub>DD</sub> | V    |
| V <sub>IH</sub>    | HIGH-level input voltage     |  | 0.7V <sub>DD</sub> | -   | 6                   | V    |
| ILI                | input leakage current        | pin at V <sub>DD</sub> or V <sub>SS</sub>  | -1                 | -   | +1                  | μΑ   |
| C <sub>i</sub>     | input capacitance            | V <sub>I</sub> = V <sub>SS</sub>   | -                  | 1.6 | 3                   | pF   |
| Pass gat           | е                            |  |                    | '   | '                   |      |
| R <sub>on</sub>    | ON-state resistance          | V <sub>DD</sub> = 3.6 V; V <sub>O</sub> = 0.4 V; I <sub>O</sub> = 15 mA                | 5                  | 11  | 30                  | Ω    |
|                    |                              | $V_{DD}$ = 2.3 V to 2.7 V; $V_{O}$ = 0.4 V; $I_{O}$ = 10 mA                            | 7                  | 16  | 55                  | Ω    |
| V <sub>o(sw)</sub> | switch output voltage        | $V_{i(sw)} = V_{DD} = 3.3 \text{ V; } I_{o(sw)} = -100  \mu\text{A}$                   | -                  | 1.9 | -                   | V    |
|                    |                              | $V_{i(sw)} = V_{DD} = 3.0 \text{ V to } 3.6 \text{ V; } I_{o(sw)} = -100  \mu\text{A}$ | 1.6                | -   | 2.8                 | V    |
|                    |                              | $V_{i(sw)} = V_{DD} = 2.5 \text{ V}; I_{o(sw)} = -100  \mu\text{A}$                    | -                  | 1.5 | -                   | V    |
|                    |                              | $V_{i(sw)} = V_{DD} = 2.3 \text{ V to } 2.7 \text{ V; } I_{o(sw)} = -100  \mu\text{A}$ | 1.1                | -   | 2.0                 | V    |
| IL                 | leakage current              | $V_I = V_{DD}$ or $V_{SS}$   | -1                 | -   | +1                  | μA   |
| C <sub>io</sub>    | input/output capacitance     | V <sub>I</sub> = V <sub>SS</sub>   | -                  | 3   | 5                   | pF   |
| INT outp           | ut                           | ,  |                    | l   | 1                   |      |
| I <sub>OL</sub>    | LOW-level output current     | V <sub>OL</sub> = 0.4 V  | 3                  | -   | -                   | mA   |
| I <sub>OH</sub>    | HIGH-level output current    |  | -                  | -   | +10                 | μA   |

For operation between published voltage ranges, refer to the worst-case parameter in both ranges.  $V_{DD}$  must be lowered to 0.2 V for at least 5  $\mu s$  in order to reset part.

#### Table 9. Static characteristics at $V_{DD}$ = 4.5 V to 5.5 V

 $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified. See <u>Table 8</u> for  $V_{DD}$  = 2.3 V to 3.6  $V_{color}^{(1)}$ .

| Symbol          | Parameter      | Conditions  | Min | Тур | Max | Unit |
|-----------------|----------------|---|-----|-----|-----|------|
| Supply          |                |   |     |     |     |      |
| $V_{DD}$        | supply voltage |   | 4.5 | -   | 5.5 | V    |
| I <sub>DD</sub> | supply current | Operating mode; $V_{DD}$ = 5.5 V; no load; $V_{I}$ = $V_{DD}$ or $V_{SS}$ ; $f_{SCL}$ = 100 kHz | -   | 25  | 100 | μΑ   |

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Table 9. Static characteristics at  $V_{DD}$  = 4.5 V to 5.5 V...continued

 $V_{SS}$  = 0 V;  $T_{amb}$  = -40 °C to +85 °C; unless otherwise specified. See <u>Table 8</u> for  $V_{DD}$  = 2.3 V to 3.6  $V_{color}^{(1)}$ .

| Symbol           | Parameter                    | Conditions  |     | Min                | Тур | Max                 | Unit |
|------------------|------------------------------|---|-----|--------------------|-----|---------------------|------|
| I <sub>stb</sub> | standby current              | Standby mode; V <sub>DD</sub> = 5.5 V; no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub> |     | -                  | 0.3 | 1                   | μΑ   |
| V <sub>POR</sub> | power-on reset voltage       | no load; V <sub>I</sub> = V <sub>DD</sub> or V <sub>SS</sub>  | [2] | -                  | 1.7 | 2.1                 | V    |
| Input SCL        | .; input/output SDA          |   |     |                    |     |                     |      |
| V <sub>IL</sub>  | LOW-level input voltage      |   |     | -0.5               | -   | +0.3V <sub>DD</sub> | V    |
| V <sub>IH</sub>  | HIGH-level input voltage     |   |     | 0.7V <sub>DD</sub> | -   | 6                   | V    |
| I <sub>OL</sub>  | LOW-level output current     | V <sub>OL</sub> = 0.4 V   |     | 3                  | -   | -                   | mA   |
|                  |                              | V <sub>OL</sub> = 0.6 V   |     | 6                  | -   | -                   | mA   |
| IL               | leakage current              | $V_I = V_{SS}$  |     | -1                 | -   | +1                  | μA   |
| C <sub>i</sub>   | input capacitance            | $V_I = V_{SS}$  |     | -                  | 10  | 13                  | pF   |
| Select inp       | outs A0, A1, INTO to INT3, R | ESET  |     |                    |     |                     |      |
| V <sub>IL</sub>  | LOW-level input voltage      |   |     | -0.5               | -   | +0.3V <sub>DD</sub> | V    |
| V <sub>IH</sub>  | HIGH-level input voltage     |   |     | 0.7V <sub>DD</sub> | -   | 6                   | V    |
| I <sub>LI</sub>  | input leakage current        | $V_I = V_{DD}$ or $V_{SS}$  |     | -1                 | -   | +1                  | μA   |
| C <sub>i</sub>   | input capacitance            | $V_I = V_{SS}$  |     | -                  | 2   | 5                   | pF   |
| Pass gate        | )                            |   |     |                    |     |                     |      |
| R <sub>on</sub>  | ON-state resistance          | $V_{DD}$ = 4.5 V to 5.5 V; $V_{O}$ = 0.4 V; $I_{O}$ = 15 mA   |     | 4                  | 9   | 24                  | Ω    |
| $V_{o(sw)}$      | switch output voltage        | $V_{i(sw)} = V_{DD} = 5.0 \text{ V}; I_{o(sw)} = -100$<br>$\mu\text{A}$                             |     | -                  | 3.6 | -                   | V    |
|                  |                              | $V_{i(sw)} = V_{DD} = 4.5 \text{ V to } 5.5 \text{ V};$<br>$I_{o(sw)} = -100  \mu\text{A}$          |     | 2.6                | -   | 4.5                 | V    |
| IL               | leakage current              | $V_I = V_{DD}$ or $V_{SS}$  |     | -1                 | -   | +1                  | μA   |
| C <sub>io</sub>  | input/output capacitance     | $V_I = V_{SS}$  |     | -                  | 3   | 5                   | pF   |
| INT outpu        | it                           |   |     |                    |     | '                   |      |
| I <sub>OL</sub>  | LOW-level output current     | V <sub>OL</sub> = 0.4 V   |     | 3                  | -   | -                   | mA   |
| I <sub>OH</sub>  | HIGH-level output current    |   |     | -                  | -   | +10                 | μA   |

For operation between published voltage ranges, refer to the worst-case parameter in both ranges.  $V_{DD}$  must be lowered to 0.2 V for at least 5  $\mu s$  in order to reset part.

# 12 Dynamic characteristics

Table 10. Dynamic characteristics

| Symbol           | Parameter           | Conditions                        | Standard-<br>mode I <sup>2</sup> C-bus |                    | Fast-mode I <sup>2</sup> C-bus |                    | Unit |
|------------------|---------------------|-----------------------------------|--|--------------------|--------------------------------|--------------------|------|
|                  |                     |                                   | Min                                    | Max                | Min                            | Max                |      |
| t <sub>PD</sub>  | propagation delay   | from SDA to SDx,<br>or SCL to SCx | -                                      | 0.3 <sup>[1]</sup> | -                              | 0.3 <sup>[1]</sup> | ns   |
| f <sub>SCL</sub> | SCL clock frequency |                                   | 0                                      | 100                | 0                              | 400                | kHz  |

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### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

Table 10. Dynamic characteristics...continued

| Symbol                     | Parameter   | Conditions  |             |                  | dard-<br>I <sup>2</sup> C-bus | Fast-mode I <sup>2</sup> C-bus        |     | Unit |
|----------------------------|---|-------------|-------------|------------------|-------------------------------|---------------------------------------|-----|------|
|                            |   |             |             | Min              | Max                           | Min                                   | Max |      |
| t <sub>BUF</sub>           | bus free time between a STOP and START condition                  |             |             | 4.7              | -                             | 1.3                                   | -   | μs   |
| t <sub>HD;STA</sub>        | hold time (repeated) START condition                              |             | [2]         | 4.0              | -                             | 0.6                                   | -   | μs   |
| t <sub>LOW</sub>           | LOW period of the SCL clock                                       |             |             | 4.7              | -                             | 1.3                                   | -   | μs   |
| t <sub>HIGH</sub>          | HIGH period of the SCL clock                                      |             |             | 4.0              | -                             | 0.6                                   | -   | μs   |
| t <sub>SU;STA</sub>        | set-up time for a repeated START condition                        |             |             | 4.7              | -                             | 0.6                                   | -   | μs   |
| t <sub>SU;STO</sub>        | set-up time for STOP condition                                    |             |             | 4.0              | -                             | 0.6                                   | -   | μs   |
| t <sub>HD;DAT</sub>        | data hold time  |             |             | 0 <sup>[3]</sup> | 3.45                          | O <sub>[3]</sub>                      | 0.9 | μs   |
| t <sub>SU;DAT</sub>        | data set-up time  |             |             | 250              | -                             | 100                                   | -   | ns   |
| t <sub>r</sub>             | rise time of both SDA and SCL signals                             |             |             | -                | 1000                          | 20 + 0.1C <sub>b</sub> <sup>[4]</sup> | 300 | ns   |
| t <sub>f</sub>             | fall time of both SDA and SCL signals                             |             |             | -                | 300                           | 20 + 0.1C <sub>b</sub> <sup>[4]</sup> | 300 | ns   |
| C <sub>b</sub>             | capacitive load for each bus line                                 |             |             | -                | 400                           | -                                     | 400 | pF   |
| t <sub>SP</sub>            | pulse width of spikes that must be suppressed by the input filter |             |             | -                | 50                            | -                                     | 50  | ns   |
| t <sub>VD;DAT</sub>        | data valid time   | HIGH-to-LOW | [5]         | -                | 1                             | -                                     | 1   | μs   |
|                            |   | LOW-to-HIGH | [5]         | -                | 0.6                           | -                                     | 0.6 | μs   |
| t <sub>VD;ACK</sub>        | data valid acknowledge time                                       |             |             | -                | 1                             | -                                     | 1   | μs   |
| INT                        |   |             |             |                  |                               |                                       |     |      |
| t <sub>v(INTnN-INTN)</sub> | valid time from INTn to INT signal                                |             |             | -                | 4                             | -                                     | 4   | μs   |
| t <sub>d(INTnN-INTN)</sub> | delay time from INTn to INT inactive                              |             |             | -                | 2                             | -                                     | 2   | μs   |
| t <sub>w(rej)L</sub>       | LOW-level rejection time  | INTn inputs |             | 1                | -                             | 1                                     | -   | μs   |
| t <sub>w(rej)H</sub>       | HIGH-level rejection time   | INTn inputs |             | 0.5              | -                             | 0.5                                   | -   | μs   |
| RESET                      |   |             | · · · · · · |                  |                               | . '                                   |     | _    |
| t <sub>w(rst)L</sub>       | LOW-level reset time  |             |             | 4                | -                             | 4                                     | -   | ns   |
| t <sub>rst</sub>           | reset time  | SDA clear   |             | 500              | -                             | 500                                   | -   | ns   |
| t <sub>REC;STA</sub>       | recovery time to START condition                                  |             |             | 0                | -                             | 0                                     | -   | ns   |

Pass gate propagation delay is calculated from the 20  $\Omega$  typical R<sub>on</sub> and the 15 pF load capacitance. [1]

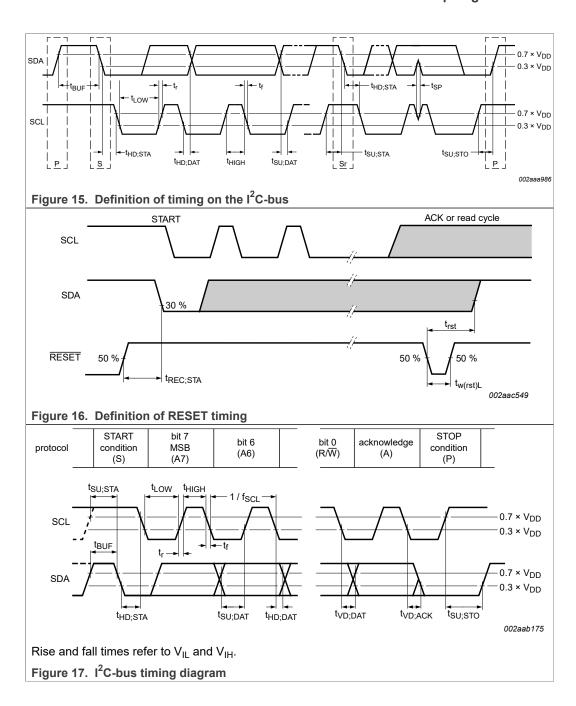
<sup>[2]</sup> After this period, the first clock pulse is generated.

A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V<sub>IH(min)</sub> of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

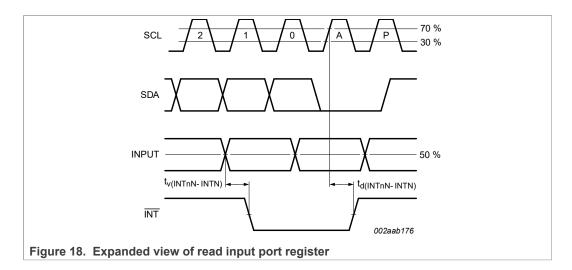
C<sub>b</sub> = total capacitance of one bus line in pF.

Measurements taken with 1 k $\Omega$  pull-up resistor and 50 pF load.

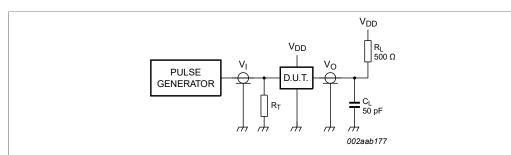
### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



## 13 Test information



#### **Definitions test circuit:**

 $R_{l}$  = Load resistance.

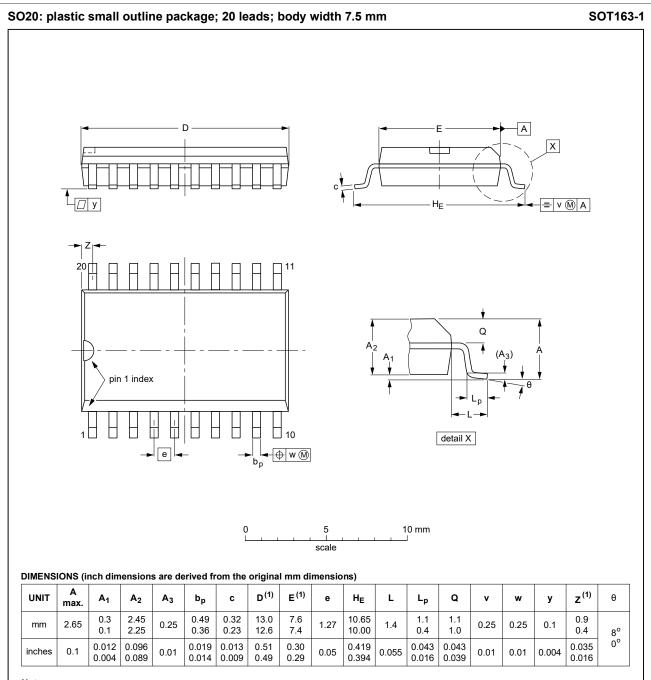
 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

Figure 19. Test circuitry for switching times

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 14 Package outline



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE  | REFERENCES |        |       | EUROPEAN | ISSUE DATE |                                 |  |
|----------|------------|--------|-------|----------|------------|---------------------------------|--|
| VERSION  | IEC        | JEDEC  | JEITA |          | PROJECTION | 1350E DATE                      |  |
| SOT163-1 | 075E04     | MS-013 |       |          |            | <del>99-12-27</del><br>03-02-19 |  |

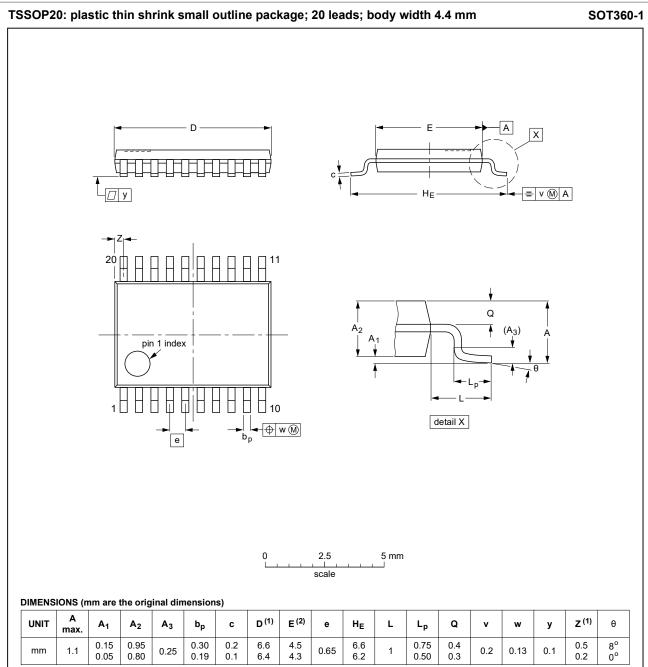
Figure 20. Package outline SOT163-1 (SO20)

PCA9545A

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4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



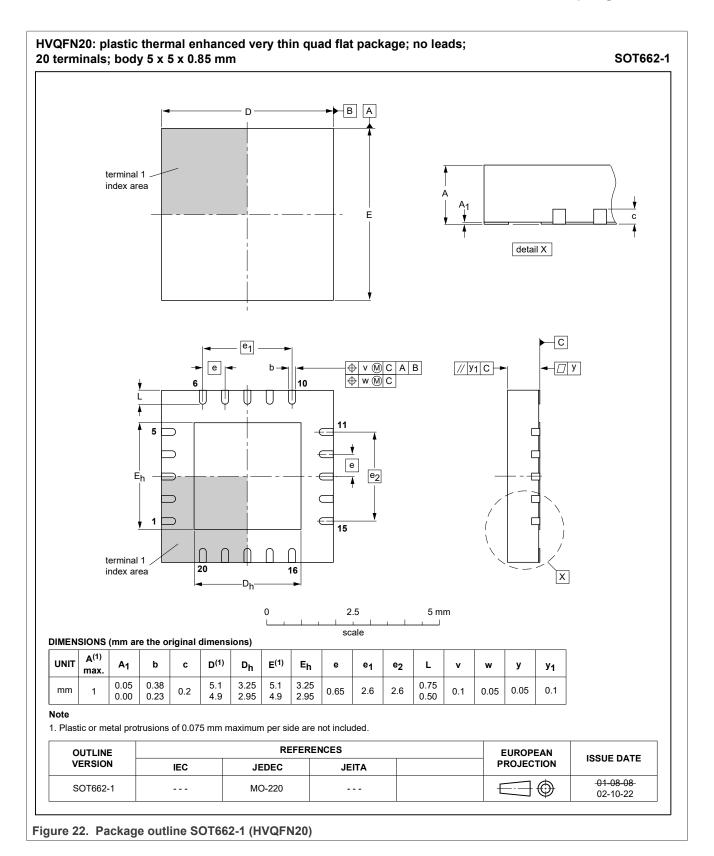
#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  | REFERENCES |        |       | EUROPEAN | ISSUE DATE |                                 |
|----------|------------|--------|-------|----------|------------|---------------------------------|
| VERSION  | IEC        | JEDEC  | JEITA |          | PROJECTION | ISSUE DATE                      |
| SOT360-1 |            | MO-153 |       |          |            | <del>99-12-27</del><br>03-02-19 |

Figure 21. Package outline SOT360-1 (TSSOP20)

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



PCA9545A

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 15 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 15.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 15.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- · Inspection and repair
- Lead-free soldering versus SnPb soldering

### 15.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

#### 15.4 Reflow soldering

Key characteristics in reflow soldering are:

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### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 23</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board
  is heated to the peak temperature) and cooling down. It is imperative that the peak
  temperature is high enough for the solder to make reliable solder joints (a solder
  paste characteristic). In addition, the peak temperature must be low enough that the
  packages and/or boards are not damaged. The peak temperature of the package
  depends on package thickness and volume and is classified in accordance with
  Table 11 and Table 12

Table 11. SnPb eutectic process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C) |       |  |  |
|------------------------|---------------------------------|-------|--|--|
|                        | Volume (mm³)                    |       |  |  |
|                        | < 350                           | ≥ 350 |  |  |
| < 2.5                  | 235                             | 220   |  |  |
| ≥ 2.5                  | 220                             | 220   |  |  |

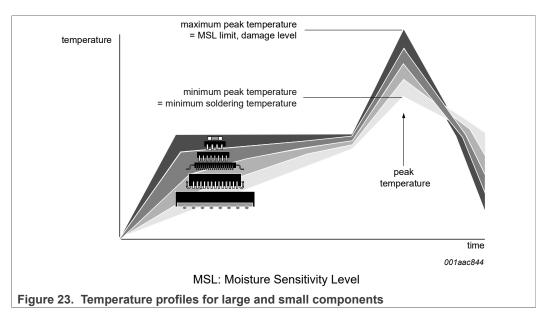
Table 12. Lead-free process (from J-STD-020D)

| Package thickness (mm) | Package reflow temperature (°C) |             |        |  |  |  |
|------------------------|---------------------------------|-------------|--------|--|--|--|
|                        | Volume (mm³)                    |             |        |  |  |  |
|                        | < 350                           | 350 to 2000 | > 2000 |  |  |  |
| < 1.6                  | 260                             | 260         | 260    |  |  |  |
| 1.6 to 2.5             | 260                             | 250         | 245    |  |  |  |
| > 2.5                  | 250                             | 245         | 245    |  |  |  |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

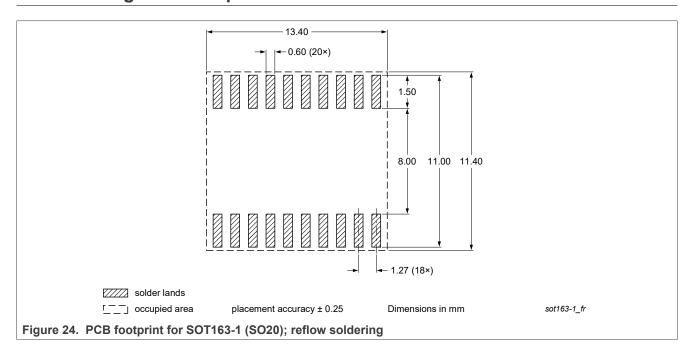
Studies have shown that small packages reach higher temperatures during reflow soldering, see <u>Figure 23</u>.

### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

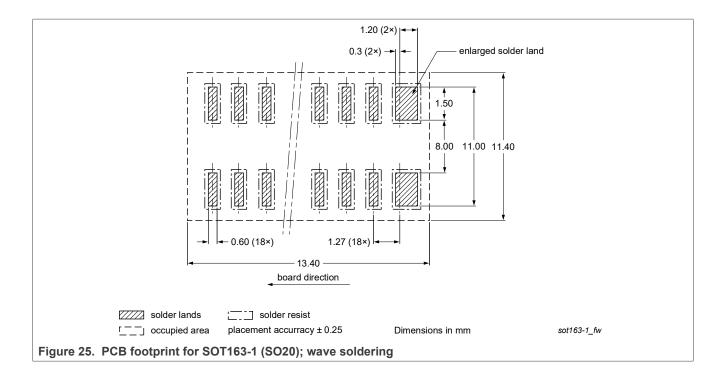


For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

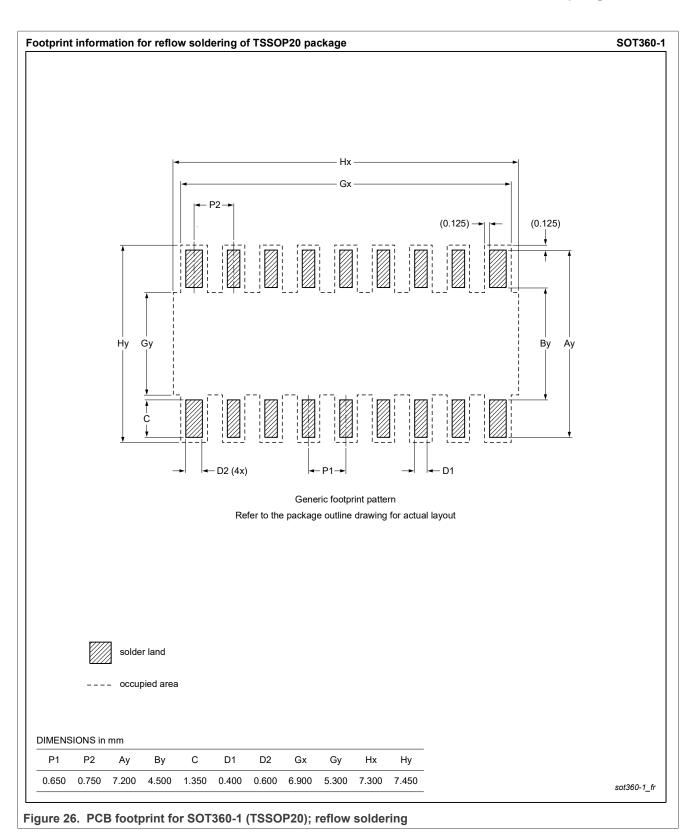
## 16 Soldering: PCB footprints



### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

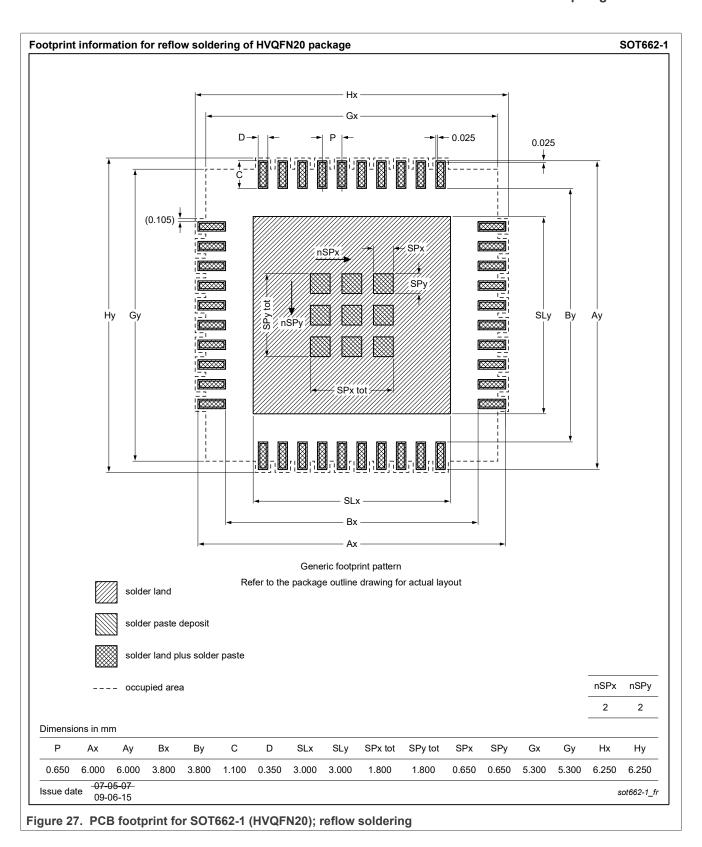


4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



PCA9545A

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset



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4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 17 Abbreviations

Table 13. Abbreviations

| Acronym              | Description                  |
|----------------------|------------------------------|
| CDM                  | Charged-Device Model         |
| DUT                  | Device Under Test            |
| ESD                  | ElectroStatic Discharge      |
| НВМ                  | Human Body Model             |
| IC                   | Integrated Circuit           |
| I <sup>2</sup> C-bus | Inter-Integrated Circuit bus |
| LSB                  | Least Significant Bit        |
| MSB                  | Most Significant Bit         |
| РСВ                  | Printed-Circuit Board        |
| POR                  | Power-On Reset               |
| SMBus                | System Management Bus        |

# 18 Revision history

Table 14. Revision history

| Document ID          | Release date   | Data sheet status   | Change notice | Supersedes           |  |  |
|----------------------|--|---|---------------|----------------------|--|--|
| PCA9545A v.10        | 20220927   | Product data sheet  | -             | PCA9545A_45B_45C v.9 |  |  |
| Modifications:       | were removed.<br>202106032DN a<br>201905028DN.<br>• The terms "mas | CA9545B and PCA9545C are identical to PCA9545A but with alternate fixed address a ere removed. PCA9545B address is 11010A1A0R/W and was in Discontinuation Notice 22106032DN and PCA9545C address is 10110A1A0R/W and was in Discontinuation Notice 22106032DN.  The terms "master" and "slave" are deprecated and have been replaced by "controller' a larget" respectively. |               |                      |  |  |
| PCA9545A_45B_45C v.9 | 20140505   | Product data sheet  | -             | PCA9545A_45B_45C v.8 |  |  |
| PCA9545A_45B_45C v.8 | 20130514   | Product data sheet  | -             | PCA9545A_45B_45C v.7 |  |  |
| PCA9545A_45B_45C v.7 | 20090619   | Product data sheet  | -             | PCA9545A_45B_45C v.6 |  |  |
| PCA9545A_45B_45C v.6 | 20070319   | Product data sheet  | -             | PCA9545A_45B_45C v.5 |  |  |
| PCA9545A_45B_45C v.5 | 20061017   | Product data sheet  | -             | PCA9545A v.4         |  |  |
| PCA9545A v.4         | 20060925   | Product data sheet  | -             | PCA9545A v.3         |  |  |
| PCA9545A v.3         | 20050303   | Product data sheet  | -             | PCA9545A v.2         |  |  |
| PCA9545A v.2         | 20040929   | Objective data sheet  | -             | PCA9545A v.1         |  |  |
| PCA9545A v.1         | 20040728   | Objective data sheet  | -             | -                    |  |  |

4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

## 19 Legal information

#### 19.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="https://www.nxp.com">https://www.nxp.com</a>.

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### 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

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# 4-channel I<sup>2</sup>C-bus switch with interrupt logic and reset

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